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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/076,653	02/19/2002	Ikuhito Onodera	111984	2584	
25944 7	590 11/17/2005	EXAMINER			
OLIFF & BE	RRIDGE, PLC	MAGEE, CHRISTOPHER R			
P.O. BOX 1992	28				
ALEXANDRIA, VA 22320			ART UNIT	PAPER NUMBER	
			2653		

DATE MAILED: 11/17/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)	
10/076,653	ONODERA, IKUHITO	
Examiner	Art Unit	
Christopher R. Magee	2653	

	Christopher R. Magee	2653						
The MAILING DATE of this communication appe	ears on the cover sheet with the c	correspondence add	ress					
THE REPLY FILED 12 October 2005 FAILS TO PLACE THIS A	THE REPLY FILED 12 October 2005 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE.							
1. The reply was filed after a final rejection, but prior to or on the same day as filing a Notice of Appeal. To avoid abandonment of this application, applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the application in condition for allowance; (2) a Notice of Appeal (with appeal fee) in compliance with 37 CFR 41.31; or (3) a Request for Continued Examination (RCE) in compliance with 37 CFR 1.114. The reply must be filed within one of the following time								
periods:  a) The period for reply expires <u>3 months from the mailing date</u>	e of the final rejection.							
<ul> <li>a) The period for reply expires 3 months from the mailing date of the linar rejection.</li> <li>b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection.</li> </ul>								
Examiner Note: If box 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN TWO MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).								
Extensions of time may be obtained under 37 CFR 1.136(a). The date have been filed is the date for purposes of determining the period of ex under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the set forth in (b) above, if checked. Any reply received by the Office later may reduce any earned patent term adjustment. See 37 CFR 1.704(b) NOTICE OF APPEAL	tension and the corresponding amount shortened statutory period for reply origi r than three months after the mailing dat	of the fee. The approprisinally set in the final Office	ate extension fee ce action; or (2) as					
2. The Notice of Appeal was filed on A brief in comp filing the Notice of Appeal (37 CFR 41.37(a)), or any exte Notice of Appeal has been filed, any reply must be filed w AMENDMENTS	nsion thereof (37 CFR 41.37(e)), to	avoid dismissal of the						
3. The proposed amendment(s) filed after a final rejection, but prior to the date of filing a brief, will not be entered because								
(a) They raise new issues that would require further co	•	ΓE below);						
(b) They raise the issue of new matter (see NOTE belo (c) They are not deemed to place the application in bel	• •	ducing or simplifying t	he issues for					
appeal; and/or (d) They present additional claims without canceling a	corresponding number of finally reig	ected claims.						
NOTE: (See 37 CFR 1.116 and 41.33(a)).								
4. The amendments are not in compliance with 37 CFR 1.1	21. See attached Notice of Non-Co	mpliant Amendment (	PTOL-324).					
5. Applicant's reply has overcome the following rejection(s)		,						
6. Newly proposed or amended claim(s) would be allowable if submitted in a separate, timely filed amendment canceling the								
non-allowable claim(s).  7.  For purposes of appeal, the proposed amendment(s): a)  will not be entered, or b)  will be entered and an explanation of how the new or amended claims would be rejected is provided below or appended.								
The status of the claim(s) is (or will be) as follows:	vided below or appended.							
Claim(s) allowed: Claim(s) objected to:	,							
Claim(s) objected to: Claim(s) rejected: <u>1-18</u> .								
Claim(s) withdrawn from consideration:								
AFFIDAVIT OR OTHER EVIDENCE	A backers and the data of City on Al	4: <b>6</b>						
8. The affidavit or other evidence filed after a final action, bubecause applicant failed to provide a showing of good anwas not earlier presented. See 37 CFR 1.116(e).								
9. The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to contain the state of the	overcome <u>all</u> rejections under appea	al and/or appellant fail	s to provide a					
showing a good and sufficient reasons why it is necessary 10.   The affidavit or other evidence is entered. An explanation			•					
REQUEST FOR RECONSIDERATION/OTHER	in of the status of the claims after ea	illy is below of attach	eu.					
11. The request for reconsideration has been considered bu See Continuation Sheet.	it does NOT place the application in	condition for allowan	ce because:					
12. Note the attached Information Disclosure Statement(s).	(PTO/SB/08 or PTO-1449) Paper N	lo(s)	1111					
13. Other:		-Llevar 5	Stalle					
11/10/2005		GEORGE J. LET	SCHEB					
Co B Marin		PRIMARY EXA	_					
U.S. Patent and Trademark Office								
PTOL-303 (Rev. 7-05) Advisory Action Before	the Filing of an Appeal Brief	Part of Pa	per No. 11102005					

Continuation of 11. does NOT place the application in condition for allowance because: As shown in Figure 7 of Kato '846, the inside metal layer 116g (i.e., element leading wire) is electrically conductive contact with substrate 101g. The inside metal layer 116g is electrically conductive contact with the lower magnetic pole 110, which is part of the thin film magnetic head assembly.